

# N-Channel CICLON NexFET™ Power MOSFETs CSD16406Q3

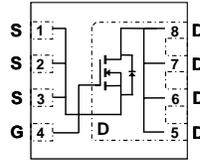


## Features

- Ultra Low Qg & Qgd
- Low Thermal Resistance
- Avalanche Rated
- Pb Free Terminal Plating
- RoHS Compliant
- Halogen Free



QFN 3.3mm x 3.3mm Plastic Package



Top View

## Product Summary

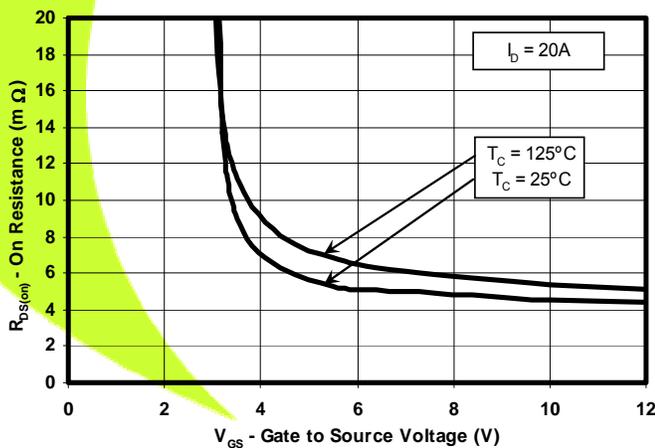
$V_{DS}$	25	V
$Q_g$	5.8	nC
$Q_{gd}$	1.5	nC
$R_{DS(on)}$	$V_{GS}=4.5V$	5.9 m $\Omega$
	$V_{GS}=10V$	4.2 m $\Omega$
$V_{th}$	1.7	V

## Maximum Values ( $T_A=25^\circ C$ unless otherwise stated)

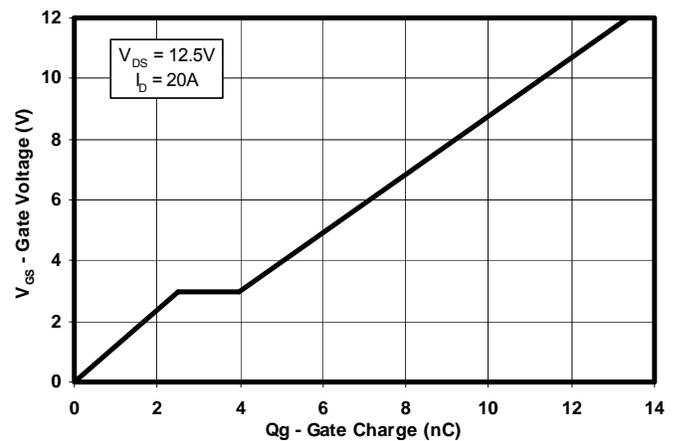
Symbol	Parameter	Value	Units
$V_{DS}$	Drain to Source Voltage	25	V
$V_{GS}$	Gate to Source Voltage	+16 / -12	V
$I_D$	Continuous Drain Current, $T_C = 25^\circ C$	60	A
	Continuous Drain Current <sup>1</sup>	19	A
$I_{DM}$	Pulsed Drain Current, $T_A = 25^\circ C^2$	114	A
$P_D$	Power Dissipation <sup>1</sup>	2.7	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ C$
$E_{AS}$	Avalanche Energy, single pulse $I_D=45A, L = 0.1mH, R_G = 25\Omega$	101	mJ

1.  $R_{\theta JA} = 46^\circ C/W$  on 1in<sup>2</sup> Cu (2 oz.) on 0.060" thick FR4 PCB.
2. Pulse width  $\leq 300 \mu s$ , duty cycle  $\leq 2\%$

## $R_{DS(on)}$ vs. $V_{GS}$



## Gate Charge



## Ordering Information

Type	Package	Package Media	Qty	Ship
CSD16406Q3	QFN 3.3 X 3.3 Plastic Package	13 inch reel	2500	Tape and Reel

N-Channel  
**CICLON NexFET™ Power MOSFETs**  
**CSD16406Q3**



**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain to Source Voltage	$V_{GS} = 0V, I_D = 250\mu A$	25	—	—	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{GS} = 0V, V_{DS} = 20V$	—	—	1	$\mu A$
$I_{GSS}$	Gate to Source Leakage Current	$V_{DS} = 0V, V_{GS} = +16/-12V$	—	—	100	nA
$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.4	1.7	2.2	V
$R_{DS(on)}$	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 20A$	—	5.9	7.4	$m\Omega$
		$V_{GS} = 10V, I_D = 20A$	—	4.2	5.3	$m\Omega$
$g_{fs}$	Transconductance	$V_{DS} = 15V, I_D = 20A$	—	53	—	S
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input Capacitance	$V_{GS} = 0V, V_{DS} = 12.5V$ $f = 1MHz$	—	840	1100	pF
$C_{OSS}$	Output Capacitance		—	680	950	pF
$C_{RSS}$	Reverse Transfer Capacitance		—	57	80	pF
$R_g$	Series Gate Resistance		—	1.4	—	$\Omega$
$Q_g$	Gate Charge Total (4.5V)	$V_{DS} = 12.5V, I_D = 20A$	—	5.8	8.1	nC
$Q_{gd}$	Gate Charge Gate to Drain		—	1.5	—	nC
$Q_{gs}$	Gate Charge Gate to Source		—	2.5	—	nC
$Q_{g(th)}$	Gate Charge at $V_{th}$		—	1.5	—	nC
$Q_{OSS}$	Output Charge	$V_{DS} = 13.6V, V_{GS} = 0V$	—	13.9	—	nC
$t_{d(on)}$	Turn On Delay Time	$V_{DS} = 12.5V$ $V_{GS} = 4.5V, I_D = 20A$ $R_G = 7.5\Omega$	—	10.4	—	ns
$t_r$	Rise Time		—	20	—	ns
$t_{d(off)}$	Turn Off Delay Time		—	9.4	—	ns
$t_f$	Fall Time		—	29	—	ns
<b>Diode Characteristics</b>						
$V_{SD}$	Diode Forward Voltage	$I_S = 20A, V_{GS} = 0V$	—	0.85	1.0	V
$Q_{rr}$	Reverse Recovery Charge	$V_{dd} = 13.6V, I_F = 20A,$ $di/dt = 300A/\mu s$	—	18	—	nC
$t_{rr}$	Reverse Recovery Time	$V_{dd} = 13.6V, I_F = 20A,$ $di/dt = 300A/\mu s$	—	22	—	ns

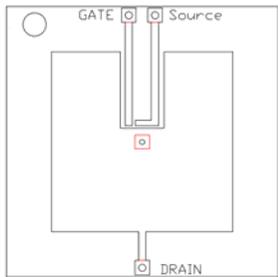
# N-Channel CICLON NexFET™ Power MOSFETs CSD16406Q3



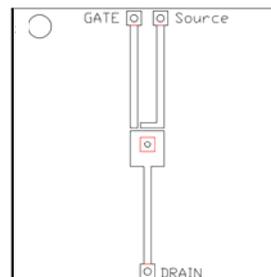
## Thermal Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise stated)

Symbol	Parameter	Min	Typ	Max	Units
<b>Thermal Characteristics</b>					
$R_{\theta JC}$	Thermal Resistance Junction to Case <sup>3</sup>	—	—	2.7	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient <sup>3,4</sup>	—	—	58	$^\circ\text{C/W}$

- $R_{\theta JC}$  is determined with the device mounted on a 1in square 2 oz. Cu pad on a 1.5x1.5 in .060in thick FR4 board.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta ca}$  is determined by the user's board design.
- Device mounted on FR4 Material with 1in<sup>2</sup> of 2 oz. Cu.



Max  $R_{\theta JA} = 58^\circ\text{C/W}$  when mounted on 1in<sup>2</sup> of 2 oz. Cu.



Max  $R_{\theta JA} = 162^\circ\text{C/W}$  when mounted on min pad area of 2 oz. Cu.

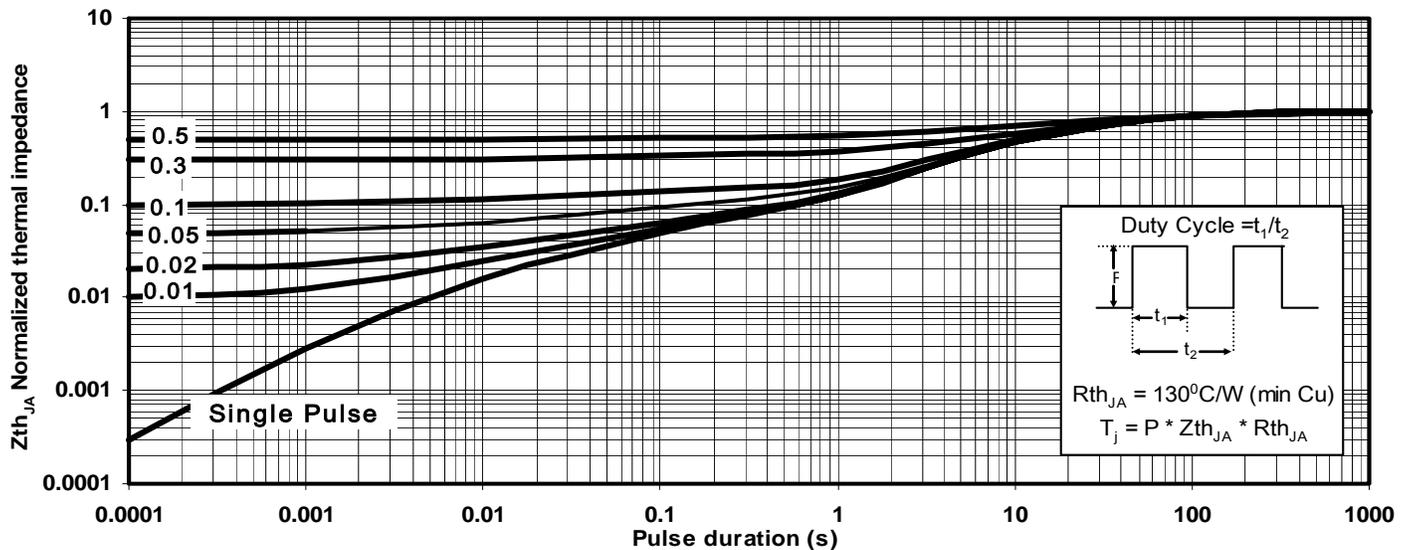


Figure 1: Transient Thermal Impedance

# N-Channel CICLON NexFET™ Power MOSFETs CSD16406Q3



Typical MOSFET Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

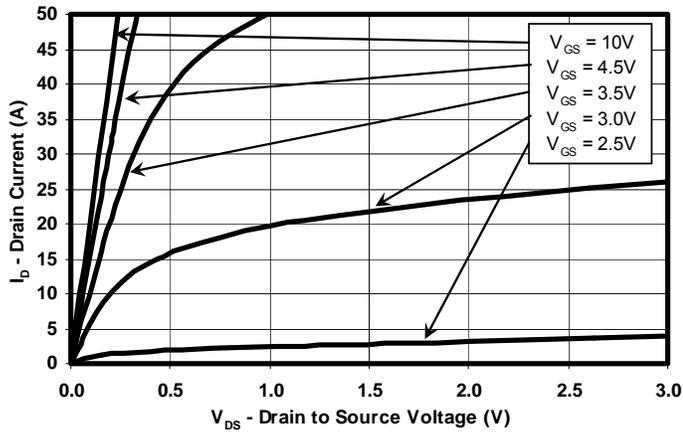


Figure 2: Saturation Characteristics

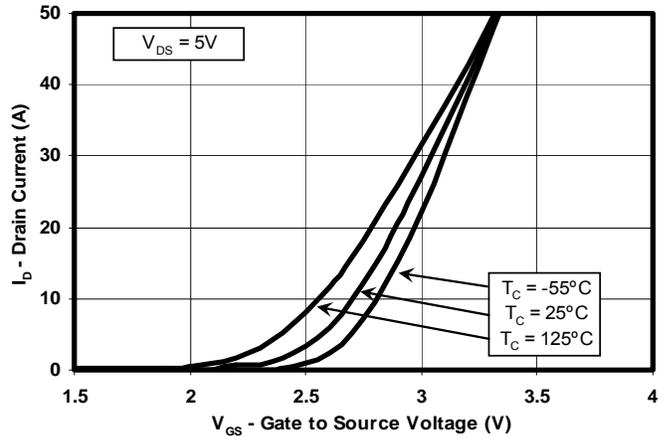


Figure 3: Transfer Characteristics

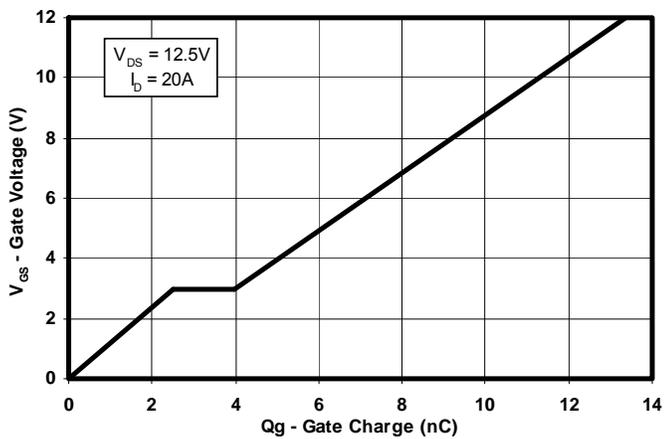


Figure 4: Gate Charge

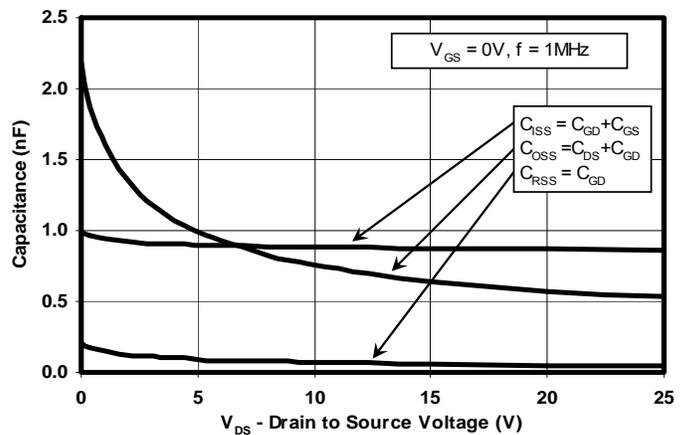


Figure 5: Capacitance

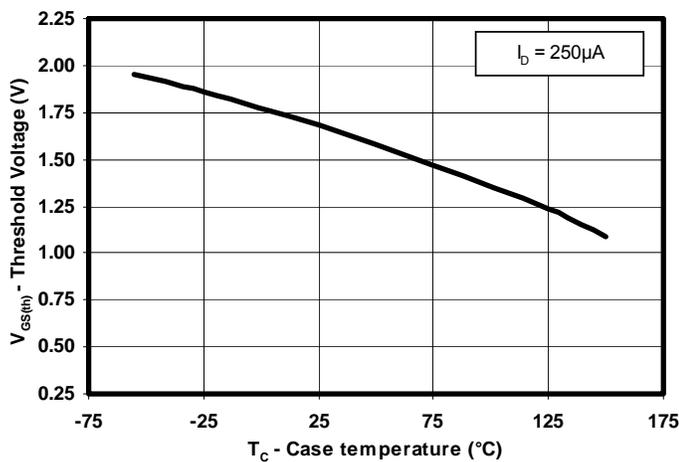


Figure 6: Threshold Voltage vs. Temperature

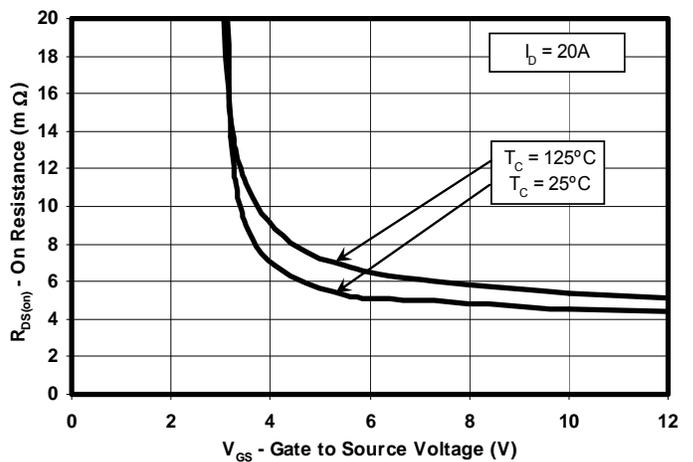


Figure 7: On Resistance vs. Gate Voltage

# N-Channel CICLON NexFET™ Power MOSFETs CSD16406Q3



## Typical MOSFET Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise stated)

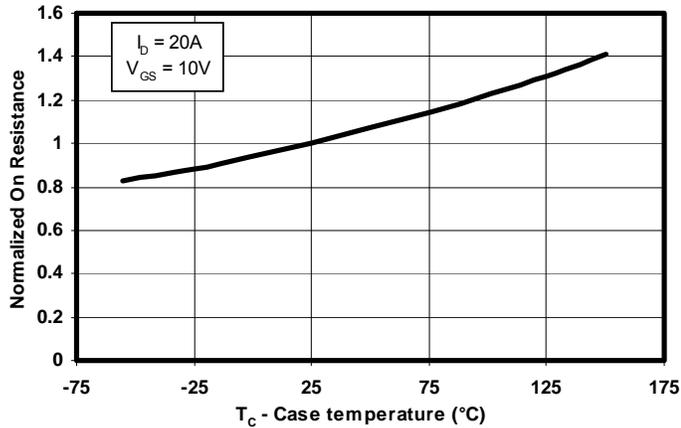


Figure 8: On Resistance vs. Temperature

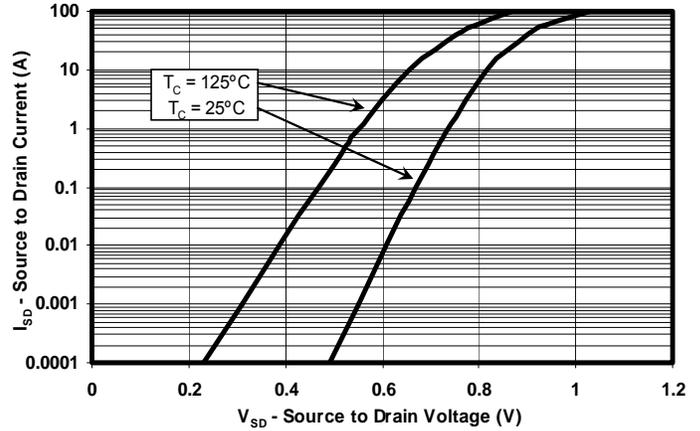


Figure 9: Typical Diode Forward Voltage

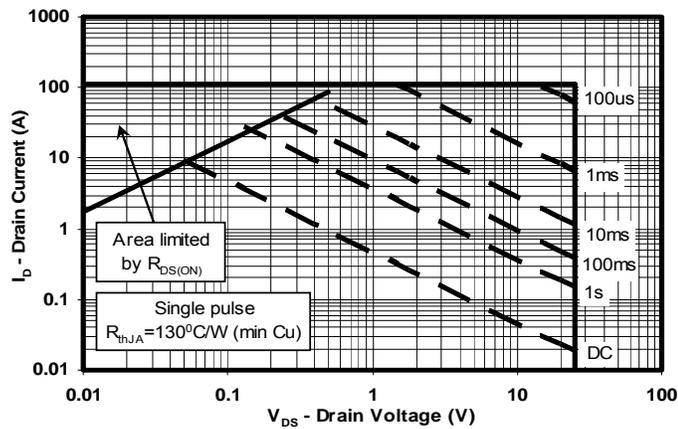


Figure 10: Maximum Safe Operating Area

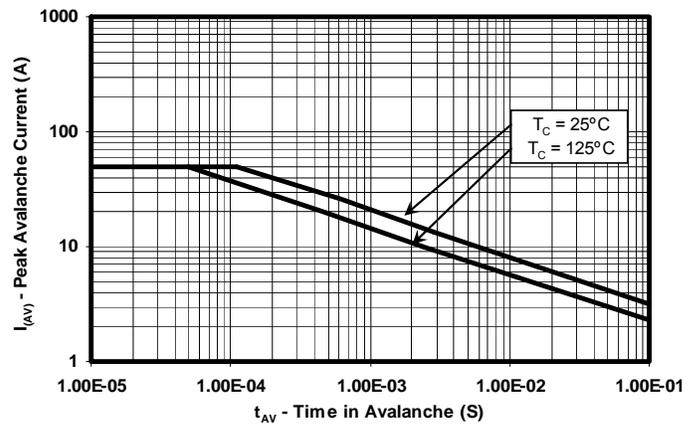


Figure 11: Single Pulse Unclamped Inductive Switching

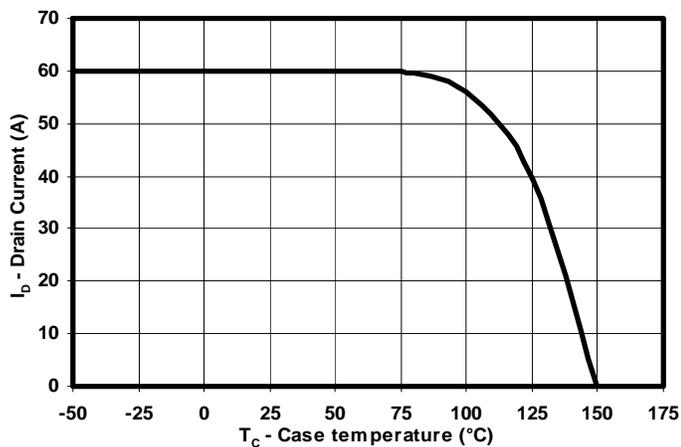
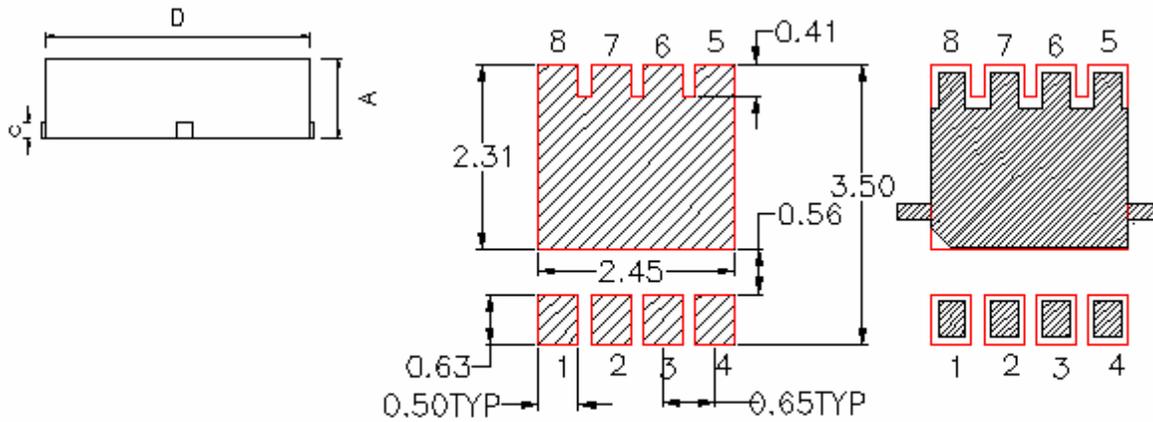
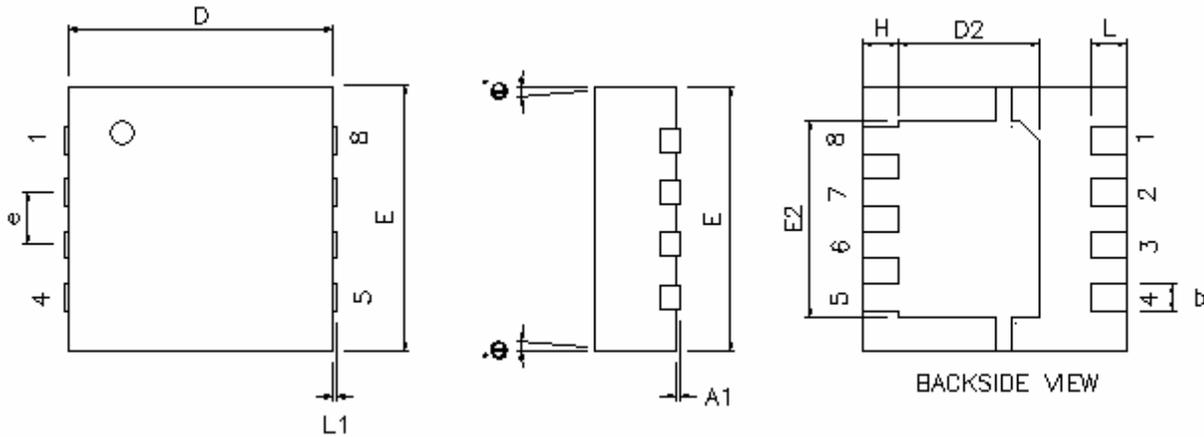


Figure 12: Maximum Drain Current vs. Temperature

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**CSD16406Q3 Package Dimensions**



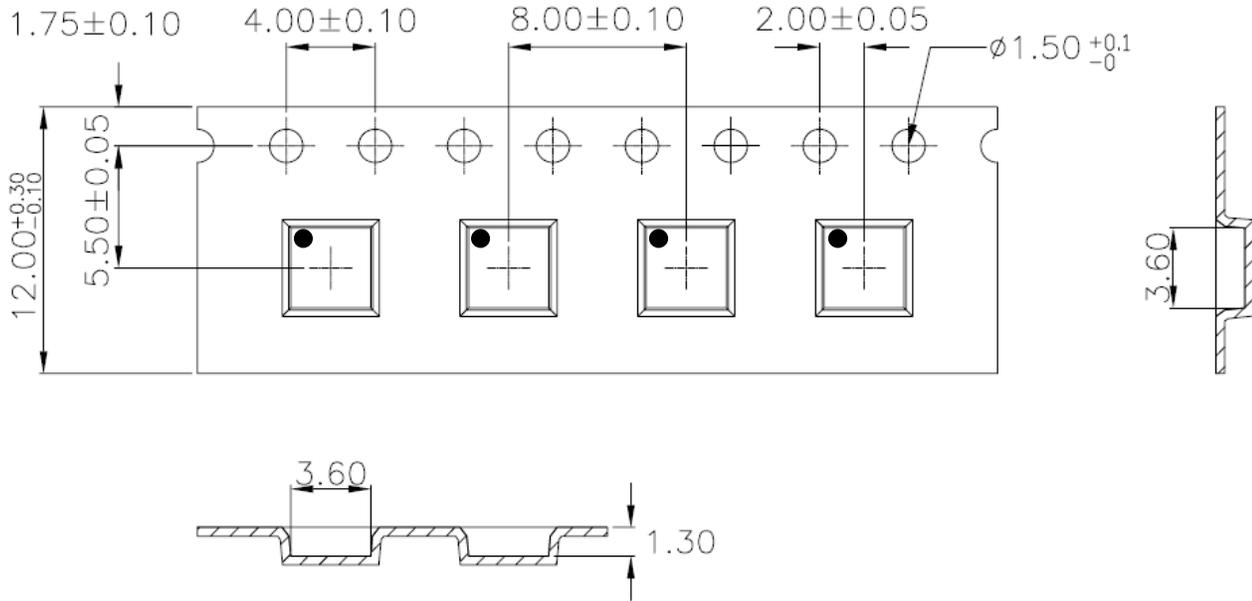
RECOMMENDED PCB LAND PATTERN

DIM	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.950	1.000	1.100	0.037	0.039	0.043
A1	0.000	0.000	0.050	0.000	0.000	0.002
b	0.280	0.340	0.400	0.011	0.013	0.016
c	0.150	0.200	0.250	0.006	0.008	0.010
D	3.200	3.300	3.400	0.126	0.130	0.134
D1	-	-	-	-	-	-
D2	1.650	1.750	1.800	0.065	0.069	0.071
E	3.200	3.300	3.400	0.126	0.130	0.134
E1	-	-	-	-	-	-
E2	2.350	2.450	2.550	0.093	0.096	0.100
e	0.650 TYP			0.026		
H	0.35	0.450	0.550	0.014	0.018	0.022
L	0.35	0.450	0.550	0.014	0.018	0.022
L1	-	-	-	-	-	-
theta	-	-	-	-	-	-

# N-Channel CICLON NexFET™ Power MOSFETs CSD16406Q3



## Q3 Tape and Reel Information



Note:

1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE +/-0.2
2. CAMBER NOT TO EXCEED 1mm IN 100mm, NONCUMULATIVE OVER 250mm
3. MATERIAL:BLACK STATIC DISSIPATIVE POLYSTYRENE
4. ALL DIMENSIONS ARE IN mm (UNLESS OTHERWISE SPECIFIED)
5. THICKNESS: 0.30 +/-0.05mm

## Package Marking Information

Location:

### 1st Line

CSD = Fixed Characters

NNNNN = Product Code

### 2nd Line (Date Code)

YY = Last 2 digits of the Year

WW = 2-digit Work Week

C = Country of Origin

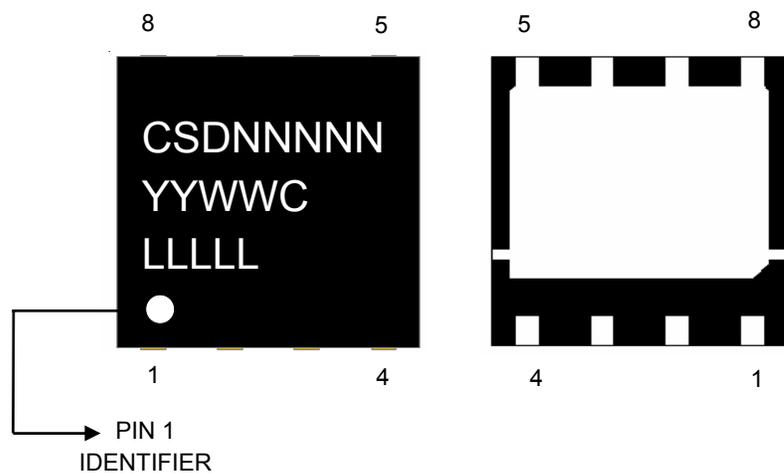
> Philippines = P

> Taiwan = T

> China = C

### 3rd Line

LLLLL = Last 5 digits of the Wafer Lot #



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